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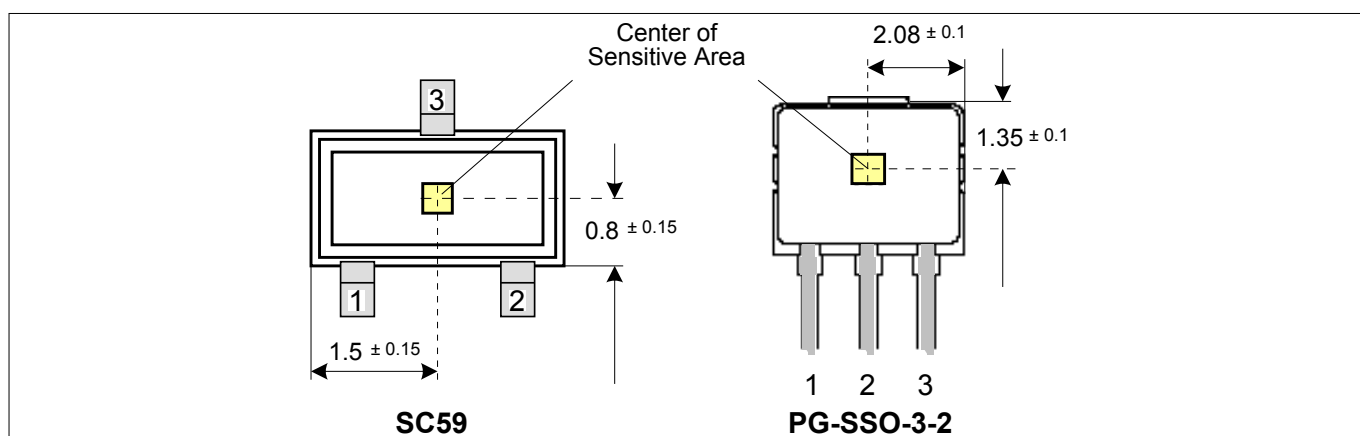
**1 Functional description**

**1 Functional description**

**1.1 General**

The TLE4906K and the TLE4906L are integrated circuit Hall-effect sensors designed specifically for highly accurate applications. Precise magnetic switching points and high temperature stability are achieved by active compensation circuits and chopper techniques on chip.

**1.2 Pin configuration (top view)**



**Figure 1** Pin configuration and center of sensitive area

**1.3 Pin description**

**Table 1** Pin description SC59

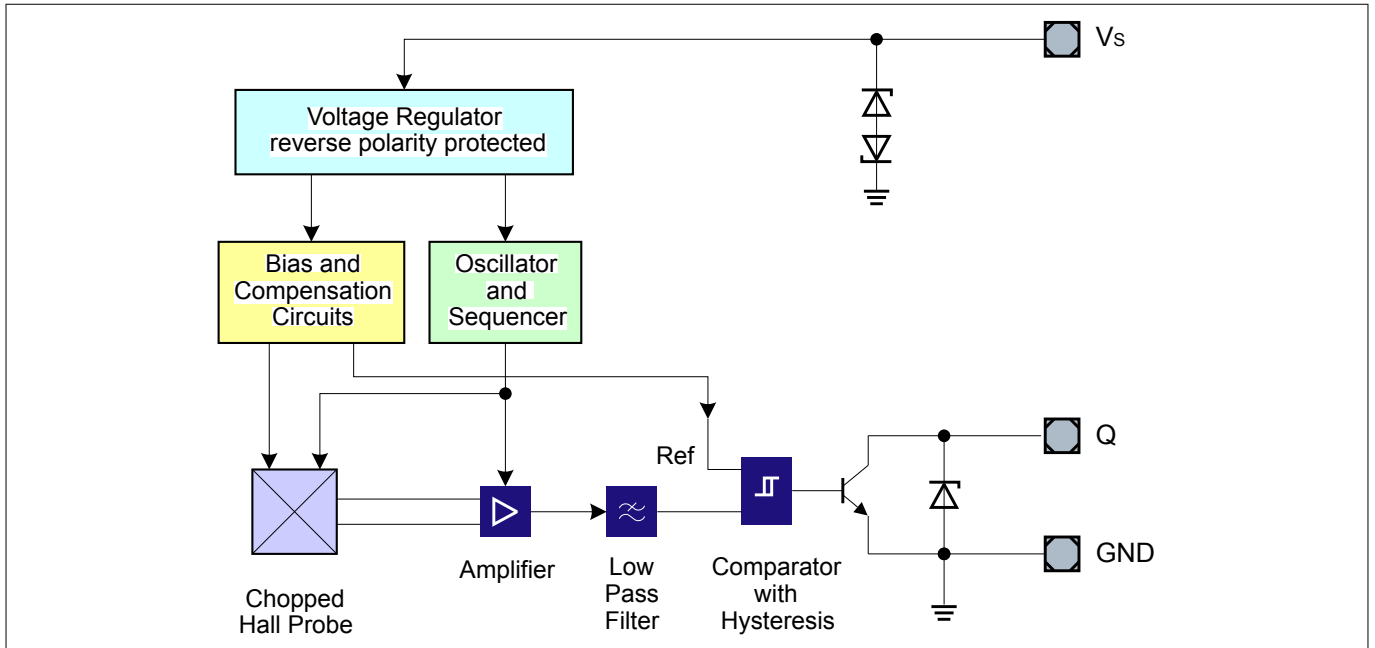
Pin No.	Symbol	Function	Comment
1	$V_S$	Supply voltage	
2	Q	Output	
3	GND	Ground	

**Table 2** Pin description PG-SSO-3-2

Pin No.	Symbol	Function	Comment
1	$V_S$	Supply voltage	
2	GND	Ground	
3	Q	Output	

**1 Functional description**

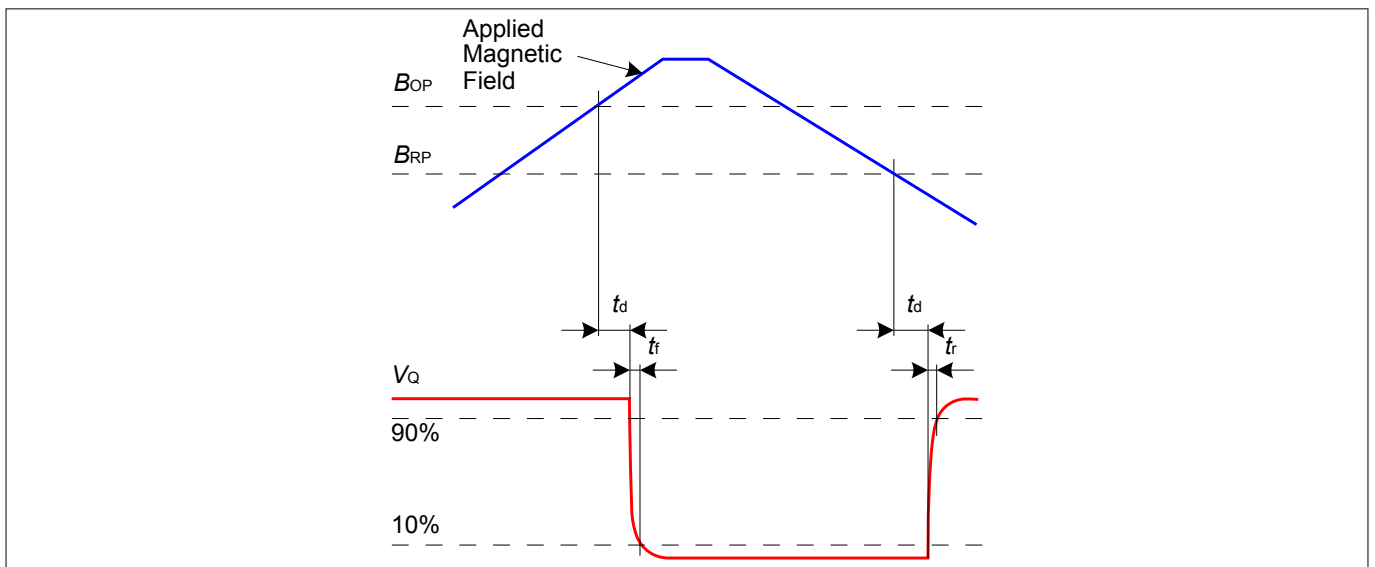
**1.4 Block diagram**



**Figure 2 Functional block diagram**

**1.5 Functional block description**

The chopped Hall IC Switch comprises a Hall probe, bias generator, compensation circuits, oscillator and output transistor. The bias generator provides currents for the Hall probe and the active circuits. Compensation circuits stabilize the temperature behavior and reduce technology variations. The Active Error Compensation rejects offsets in signal stages and the influence of mechanical stress to the Hall probe caused by molding and soldering processes and other thermal stresses in the package. This chopper technique together with the threshold generator and the comparator ensure high accurate magnetic switching points.



**Figure 3 Timing diagram**

1 Functional description

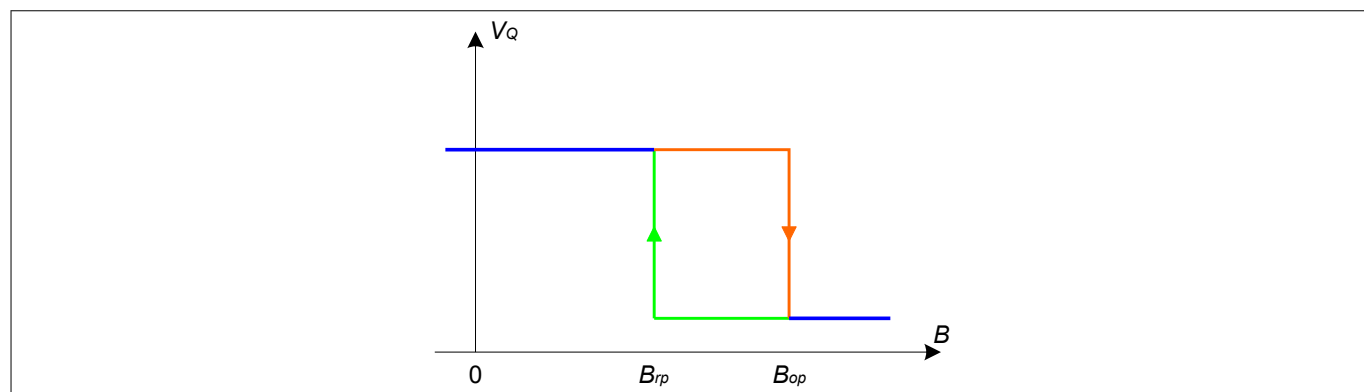


Figure 4 Output signal

**2 Specification**

**2 Specification**

**2.1 Absolute maximum ratings**

**Table 3 Absolute maximum rating parameters**

$T_j = -40^\circ\text{C}$  to  $150^\circ\text{C}$

Parameter	Symbol	Limit Values		Unit	Note/Test Condition
		Min.	Max.		
Supply voltage	$V_S$	-18	18	V	for 1 h, $R_S \geq 200 \Omega$ for 5 min, $R_S \geq 200 \Omega$
		-18	24		
		-18	26		
Supply current through protection device	$I_S$	-50	50	mA	
Output voltage	$V_Q$	-0.7	18	V	for 5 min @ 1.2 k $\Omega$ pull up
		-0.7	26		
Continuous output current	$I_Q$	-50	50	mA	
Junction temperature	$T_j$	-	155	$^\circ\text{C}$	for 2000 h (not additive) for 1000 h (not additive) for 168 h (not additive) for 3 x 1 h (additive)
		-	165		
		-	175		
		-	195		
Storage temperature	$T_S$	-40	150	$^\circ\text{C}$	
Magnetic flux density	$B$	-	unlimited	mT	

*Note: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.*

**Table 4 ESD protection<sup>(1)</sup>**

Parameter	Symbol	Limit Values		Unit	Note/Test Condition
		Min.	Max.		
ESD Voltage	$V_{\text{ESD}}$		$\pm 6$	kV	HBM, $R = 1.5 \text{ k}\Omega$ , $C = 100 \text{ pF}$ $T_A = 25^\circ\text{C}$

<sup>(1)</sup> Human Body Model (HBM) tests according to: EOS/ESD Association Standard S5.1-1993 and Mil. Std. 883D method 3015.7

## 2 Specification

### 2.2 Operating range

The following operating conditions must not be exceeded in order to ensure correct operation of the TLE4906K / TLE4906L. All parameters specified in the following sections refer to these operating conditions unless otherwise mentioned.

**Table 5** Operating conditions parameters

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Supply voltage	$V_S$	2.7		18	V	
Output voltage	$V_Q$	-0.7		18	V	
Junction temperature	$T_j$	-40		150	°C	
Output current	$I_Q$	0		20	mA	

### 2.3 Electrical and magnetic characteristics

Product characteristics involve the spread of values guaranteed within the specified voltage and ambient temperature range. Typical characteristics are the median of the production.

**Table 6** General electrical characteristics<sup>(1)</sup>

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Supply current	$I_S$	2	4	6	mA	$V_S = 2.7\text{ V} \dots 18\text{ V}$
Reverse current	$I_{SR}$	0	0.2	1	mA	$V_S = -18\text{ V}$
Output saturation voltage	$V_{QSAT}$	-	0.3	0.6	V	$I_Q = 20\text{ mA}$
Output leakage current	$I_{QLEAK}$	-	0.05	10	µA	for $V_Q = 18\text{ V}$
Output fall time	$t_f$	-	0.02	1	µs	$R_L = 1.2\text{ k}\Omega$ ; $C_L = 50\text{ pF}$ see <a href="#">Figure 3</a>
Output rise time	$t_r$	-	0.4	1	µs	
Chopper frequency	$f_{OSC}$	-	320	-	kHz	
Switching frequency	$f_{SW}$	0	-	15 <sup>(2)</sup>	kHz	
Delay time <sup>(3)</sup>	$t_d$	-	13	-	µs	
Output jitter <sup>(4)</sup>	$t_{QJ}$	-	1	-	µs <sub>RMS</sub>	typical value for square wave signal with 1 kHz
Power-on time <sup>(5)</sup>	$t_{PON}$	-	13	-	µs	$V_S \geq 2.7\text{ V}$
Thermal resistance <sup>(6)</sup>	$R_{thJA}$	-	100	-	K/W	SC59
		-	-	190		PG-SSO-3-2

- (1) over operating range, unless otherwise specified. Typical values correspond to  $V_S = 12\text{ V}$  and  $T_A = 25^\circ\text{C}$
- (2) To operate the sensor at the max. switching frequency, the value of the magnetic signal amplitude must be 1.4 times higher than for static fields. This is due to the -3 dB corner frequency of the low pass filter in the signal path.
- (3) Systematic delay between magnetic threshold reached and output switching.

**2 Specification**

- (4) Jitter is the unpredictable deviation of the output switching delay.
- (5) Time from applying  $V_S \geq 2.7\text{ V}$  to the sensor until the output state is valid
- (6) Thermal resistance from junction to ambient.

**Calculation of the ambient temperature (SC59 example)**

e.g. for  $V_S = 12.0\text{ V}$ ,  $I_{Styp} = 4\text{ mA}$ ,  $V_{QSATtyp} = 0.3\text{ V}$  and  $I_Q = 20\text{ mA}$   
 Power dissipation  $P_{DIS} = 54.0\text{ mW}$   
 $\ln T_A = T_j - (R_{thJA} \times P_{DIS}) = 175^\circ\text{C} - (100\text{ K/W} \times 0.054\text{ W})$   
 Resulting max. ambient temperature:  $T_A = 169.6^\circ\text{C}$

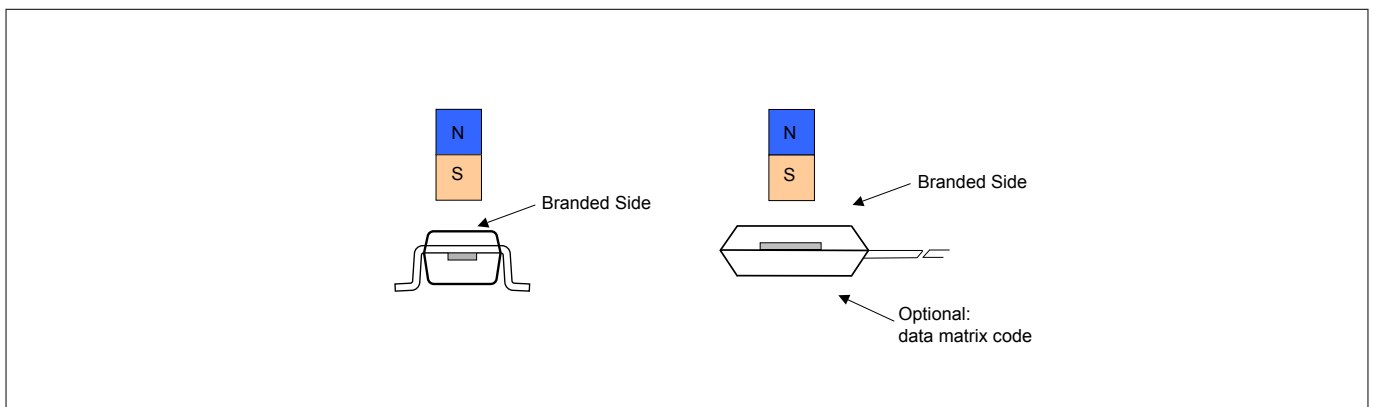
**Table 7**      **Magnetic characteristics<sup>(1)</sup>**

Parameter	Symbol	Tj[°C]	Values			Unit	Note or Test Condition
			Min.	Typ.	Max.		
Operating point	$B_{OP}$	-40	6.7	10.3	13.9	mT	
		25	6.5	10.0	13.5		
		150	6.2	9.5	12.9		
Release point	$B_{RP}$	-40	5.2	8.7	12.3	mT	
		25	5.0	8.5	12.0		
		150	4.7	8.1	11.4		
Hysteresis	$B_{HYS}$	-40	-	-	-	mT	
		25	0.7	1.5	3.0		
		150	-	-	-		
Temperature compensation of magnetic thresholds	$T_C$		-	-350	-	pmm/°C	
Repeatability of magnetic thresholds <sup>(2)</sup>	$B_{REP}$		-	20	-	$\mu\text{T}_{RMS}$	typ. value for $\Delta B/\Delta t > 12\text{ mT/ms}$

- (1) over operating range, unless otherwise specified. Typical values correspond to  $V_S = 12\text{ V}$  and  $T_A = 25^\circ\text{C}$ .
- (2)  $B_{REP}$  is equivalent to the noise constant

**Field direction definition**

Positive magnetic fields are defined with the south pole of the magnet to the branded side of package.



**Figure 5**      **Definition of magnetic field direction (left: SC59, right: PG-SSO-3-2)**

3 Package information

3 Package information

3.1 Package outline

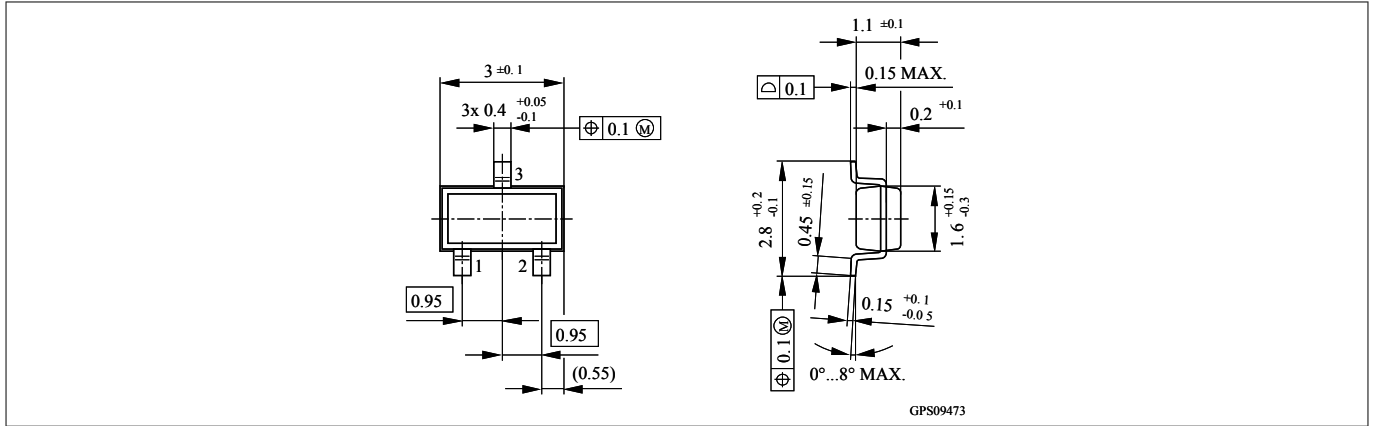


Figure 6 SC59 Package outline (all dimensions in mm)

The following picture shows a recommendation for the PCB layout.

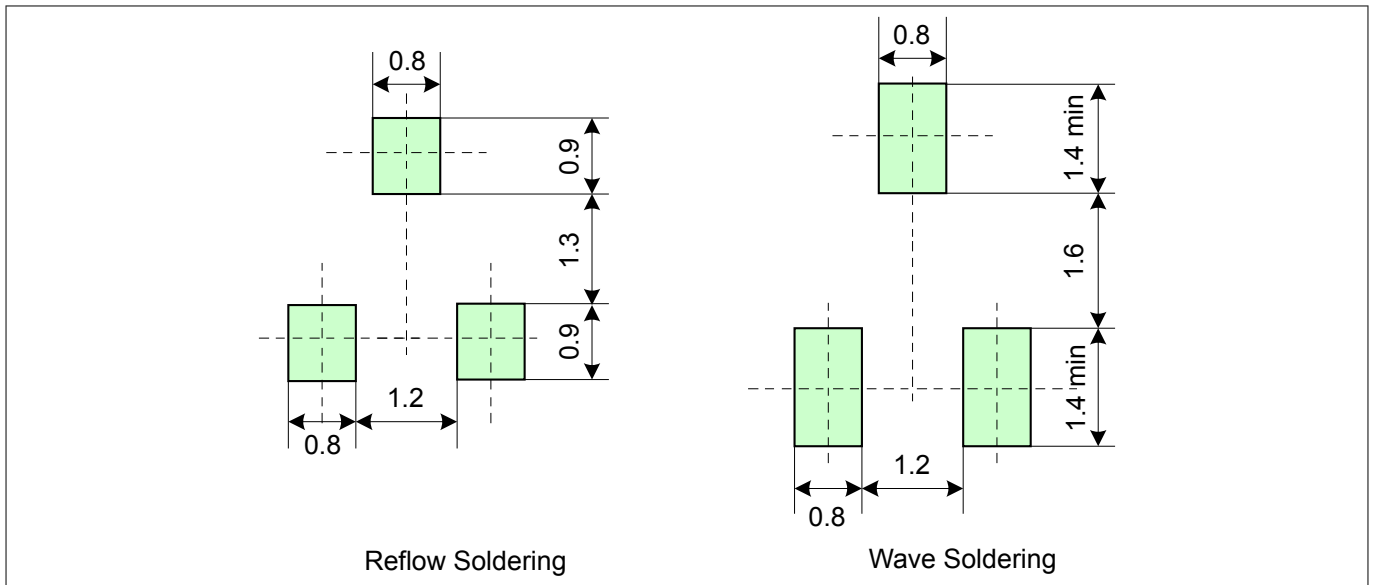
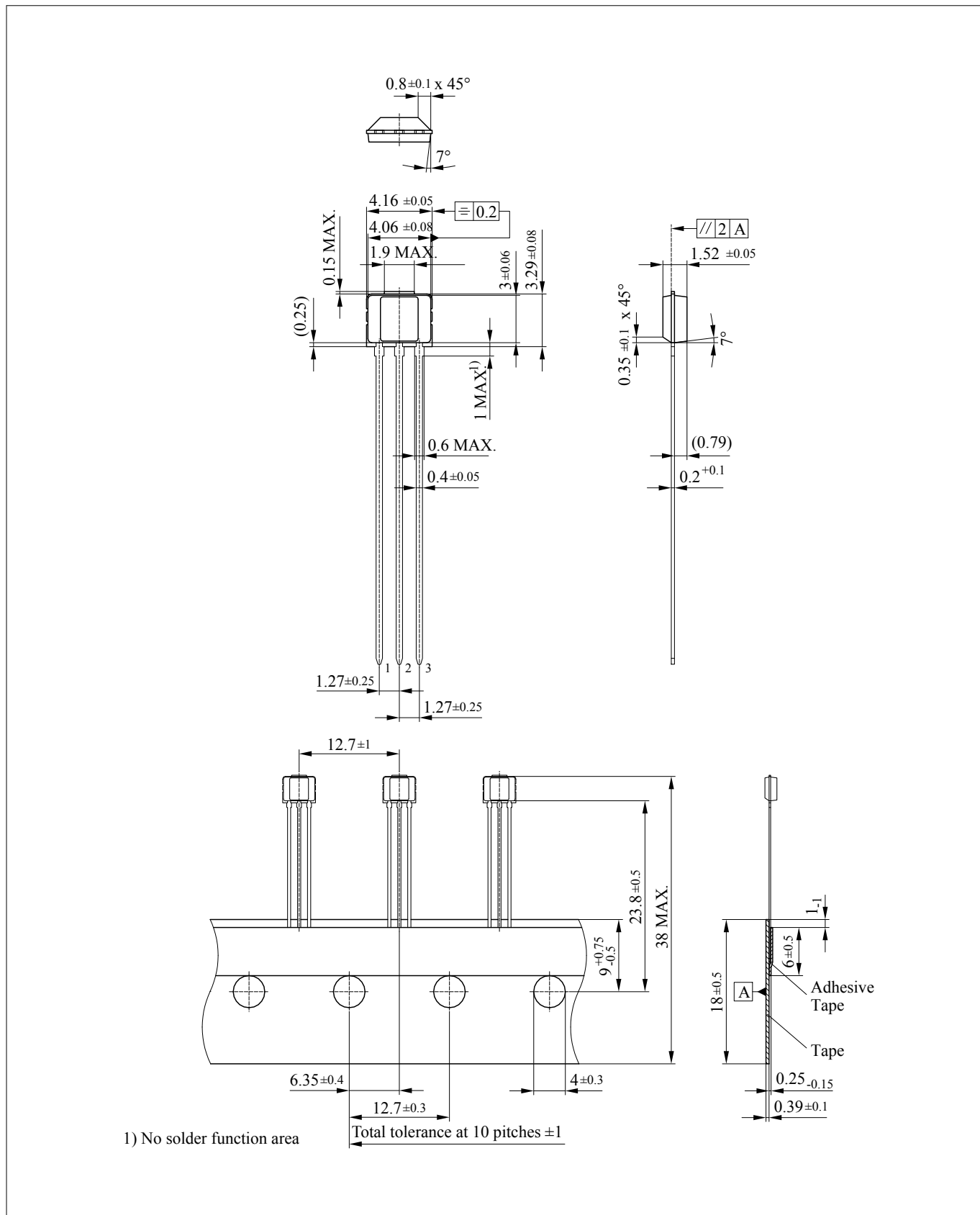


Figure 7 SC59 Footprint (SOT23 compatible, all dimensions in mm)



**3 Package information**



**Figure 8 PG-SSO-3-2 Package outline (All dimensions in mm)**

3 Package information

3.2 Distance between chip and package

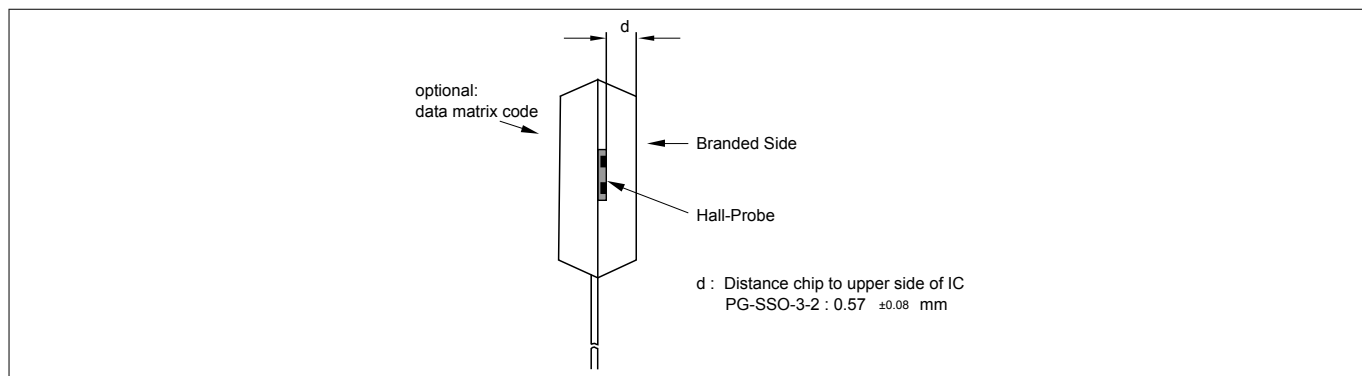


Figure 9 Distance between chip and package PG-SSO-3-2

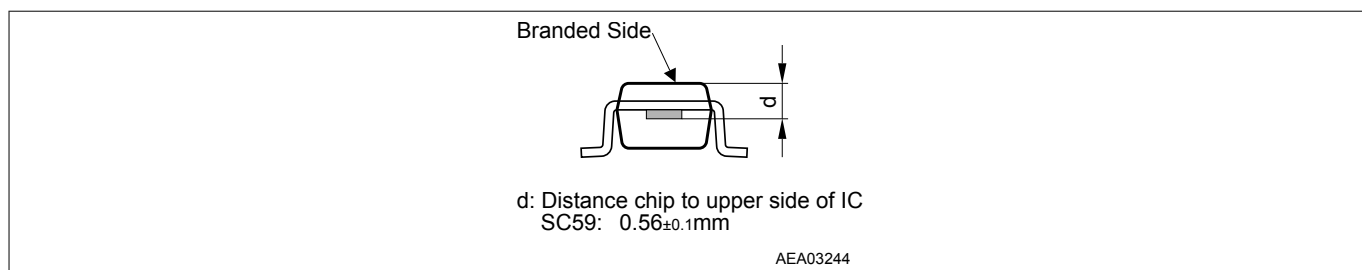


Figure 10 Distance between chip and package SC59

3.3 Package marking

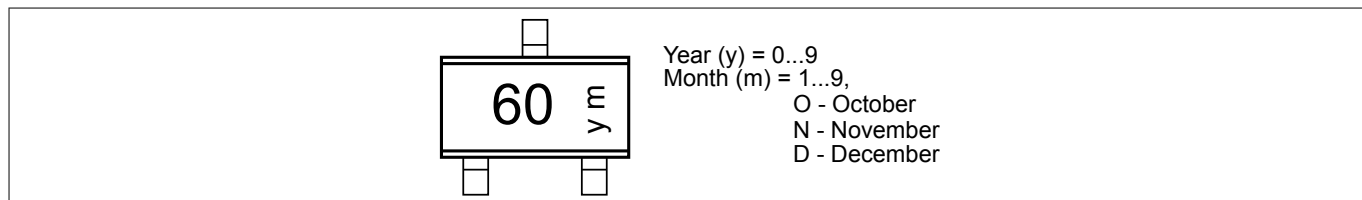


Figure 11 Marking of TLE4906K

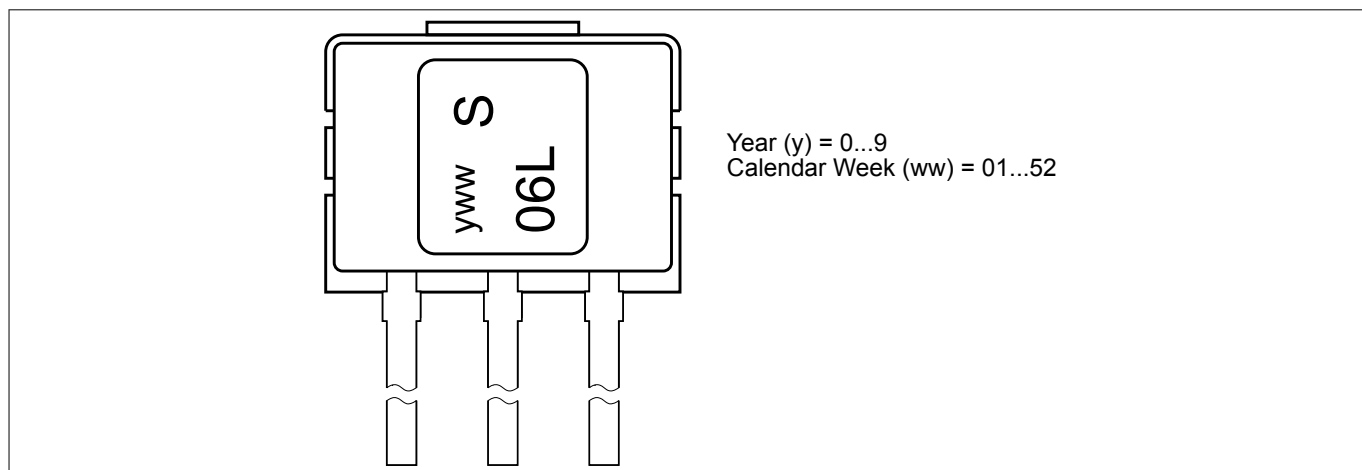


Figure 12 Marking of TLE4906L

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Revision history

## Revision history

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**Revision History**

<b>Page</b>	<b>Subjects (major changes since last revision)</b>
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Revision History: 2020-08, V 2.1

Previous Version: 2.0

13	Edited figure 9 (optional: data matrix code)

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